



# Power MOSFETS

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## DATASHEET

**LM40018NAM8A**

N-Channel  
Enhancement Mode MOSFET

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Quality Management Systems  
ISO 9001:2015 Certificate

## N-Channel Enhancement Mode MOSFET

## Pin Description

LFPAK56		Symbol	Product Summary
Top view	Bottom view		
			<b>Symbol</b>
			<b>N-Channel</b>
			<b>Unit</b>
			$V_{DSS}$ 45 V
			$R_{DS(ON)-Max}$ 2.0 mΩ
			ID 132 A

## Feature

- Fast switching speed
- Reliable and Rugged
- ROHS Compliant & Halogen-Free
- 100% UIS and Rg Tested
- Moisture Sensitivity Level MSL1

## Applications

- DC-to-DC converters
- Switch Mode Power Supply
- Brushless DC motor control

## Ordering Information

Orderable Part Number	Package Type	Form	Shipping	Marking
LM40018NAM8A	LFPAK56	Tape & Reel	4000 / Tape & Reel	40018 <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/>

Note :      = Lot CodeAbsolute Maximum Ratings ( $T_J=25^\circ\text{C}$  Unless Otherwise Noted)

Symbol	Parameter	N-Channel	Unit
$V_{DSS}$	Drain-Source Voltage	45	V
$V_{GSS}$	Gate-Source Voltage	$\pm 20$	
$T_J$	Maximum Junction Temperature	175	$^\circ\text{C}$
$T_{STG}$	Storage Temperature Range	-55 to 175	$^\circ\text{C}$
$I_S$	Diode Continuous Forward Current	$T_c=25^\circ\text{C}$	A
$I_{SP}$	Diode Pulse Current	$T_c=25^\circ\text{C}$	$400^{\circ\text{C}}$
$I_{DM}$	Pulse Drain Current Tested	$T_c=25^\circ\text{C}$	A
$I_D$	Continuous Drain Current	$T_c=25^\circ\text{C}$	
		$T_c=100^\circ\text{C}$	A
$P_D$	Maximum Power Dissipation	$T_c=25^\circ\text{C}$	W
		$T_c=100^\circ\text{C}$	
$I_D$	Continuous Drain Current	$T_A=25^\circ\text{C}$	
		$T_A=70^\circ\text{C}$	A
$P_D$	Maximum Power Dissipation	$T_A=25^\circ\text{C}$	W
		$T_A=70^\circ\text{C}$	
$I_{AS}^{\circ\text{C}}$	Avalanche Current, Single pulse	L=0.2mH	A
		L=0.5mH	
$E_{AS}^{\circ\text{C}}$	Avalanche Energy, Single pulse	L=0.2mH	mJ
		L=0.5mH	

## Thermal Characteristics

Symbol	Parameter	Rating	Unit
$R_{\theta JC}$	Thermal Resistance-Junction to Case	Steady State	$^\circ\text{C/W}$
$R_{\theta JA}^{\circ\text{C}}$	Thermal Resistance-Junction to Ambient	Steady State	$^\circ\text{C/W}$

Note ① : Max. current is limited by bonding

Note ② : UIS tested and pulse width are limited by maximum junction temperature  $175^\circ\text{C}$ Note ③ : Surface Mounted on 1in<sup>2</sup> FR-4 board with 1oz

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## N-Channel Electrical Characteristics ( $T_J=25^\circ\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
<b>Static Electrical Characteristics</b>						
$\mathbf{BV_{DSS}}$	Drain-Source Breakdown Voltage	$V_{GS}=0\text{V}, I_{DS}=250\mu\text{A}$	45	-	-	V
$\mathbf{BV_{DSS}}$	Drain-Source Breakdown Voltage (transient)	$V_{GS}=0\text{V}, I_{DS}(\text{aval})=35\text{ A}, \text{time} < 100\text{ }\mu\text{s}$	48	-	-	V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS}=32\text{V}, V_{GS}=0\text{V}$	-	-	1	$\mu\text{A}$
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_{DS}=250\mu\text{A}$	1.3	1.7	2.3	V
$I_{GSS}$	Gate Leakage Current	$V_{GS}=\pm 20\text{V}, V_{DS}=0\text{V}$	-	-	$\pm 100$	nA
$R_{DS(\text{ON})}^{\textcircled{④}}$	Drain-Source On-state Resistance	$V_{GS}=10\text{V}, I_{DS}=20\text{A}$	-	1.65	2.0	$\text{m}\Omega$
		$V_{GS}=4.5\text{V}, I_{DS}=15\text{A}$	-	3.4	4.4	
$g_{fs}$	Forward Transconductance	$V_{DS}=5\text{V}, I_{DS}=10\text{A}$	-	40	-	S
<b>Dynamic Characteristics <sup>⑤</sup></b>						
$R_G$	Gate Resistance	$V_{GS}=0\text{V}, V_{DS}=0\text{V}, \text{Freq.}=1\text{MHz}$	-	1.3	-	$\Omega$
$C_{iss}$	Input Capacitance	$V_{GS}=0\text{V}, V_{DS}=20\text{V}, \text{Freq.}=1\text{MHz}$	-	2303	-	$\text{pF}$
$C_{oss}$	Output Capacitance		-	741	-	
$C_{rss}$	Reverse Transfer Capacitance		-	73	-	
$t_{d(\text{ON})}$	Turn-on Delay Time	$V_{GS}=10\text{V}, V_{DS}=20\text{V}, I_D=1\text{A}, R_{GEN}=1\Omega$	-	12	-	$\text{nS}$
$t_r$	Turn-on Rise Time		-	10	-	
$t_{d(\text{OFF})}$	Turn-off Delay Time		-	29	-	
$t_f$	Turn-off Fall Time		-	49	-	
$Q_g$	Total Gate Charge	$V_{GS}=4.5\text{V}, V_{DS}=20\text{V}, I_D=20\text{A}$		16		$\text{nC}$
$Q_g$	Total Gate Charge	$V_{GS}=10\text{V}, V_{DS}=20\text{V}, I_D=20\text{A}$	-	33	-	$\text{nC}$
$Q_{gs}$	Gate-Source Charge		-	8	-	
$Q_{gd}$	Gate-Drain Charge		-	5	-	
<b>Source-Drain Characteristics</b>						
$V_{SD}^{\textcircled{④}}$	Diode Forward Voltage	$I_{SD}=25\text{A}, V_{GS}=0\text{V}$	-	0.75	1.1	V
$t_{rr}$	Reverse Recovery Time	$I_F=10\text{A}, V_R=20\text{V}$	-	36	-	$\text{nS}$
$Q_{rr}$	Reverse Recovery Charge	$dI_F/dt=100\text{A}/\mu\text{s}$	-	27	-	$\text{nC}$

Note ④ : Pulse test (pulse width $\leq 300\mu\text{s}$ , duty cycle $\leq 2\%$ ).

Note ⑤ : Guaranteed by design, not subject to production testing.

## N-Channel Typical Characteristics

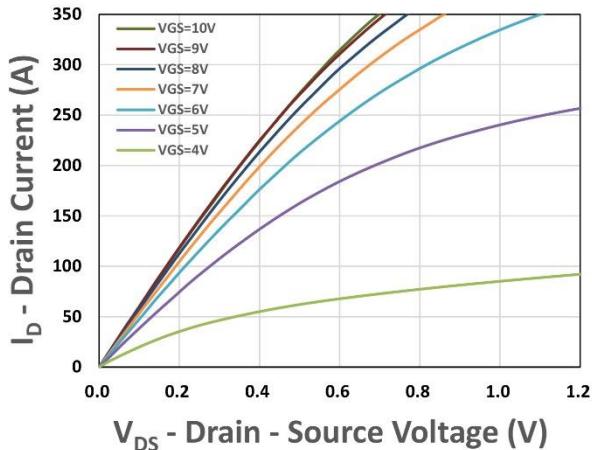


Figure 1. Output Characteristics

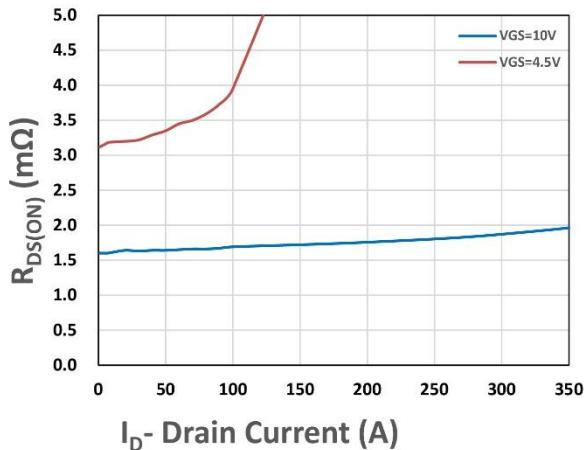


Figure 2. On-Resistance vs. ID

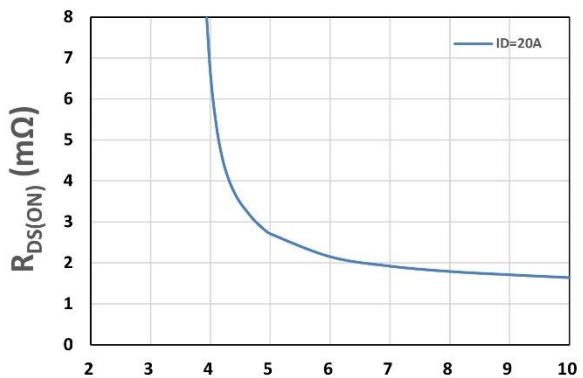


Figure 3. On-Resistance vs. VGS

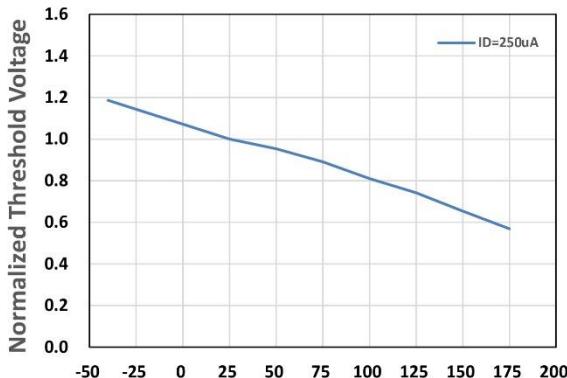


Figure 4. Gate Threshold Voltage

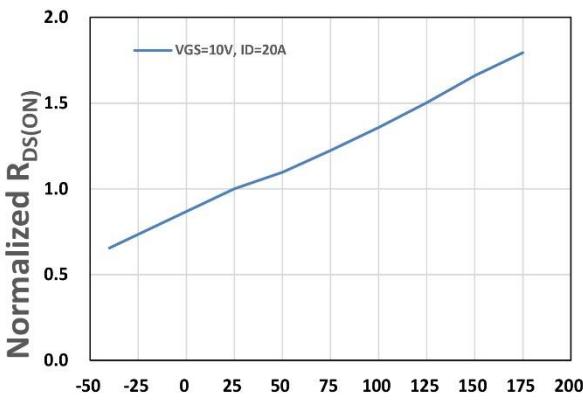


Figure 5. Drain-Source On Resistance

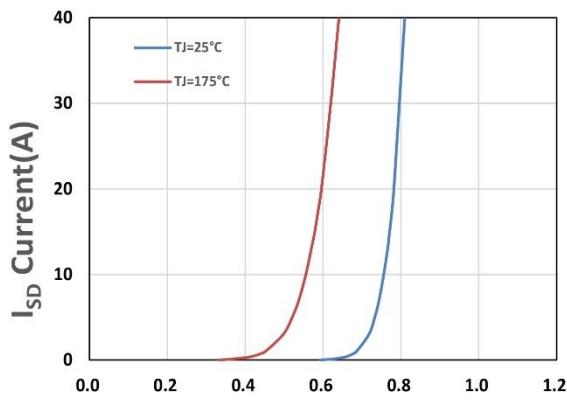
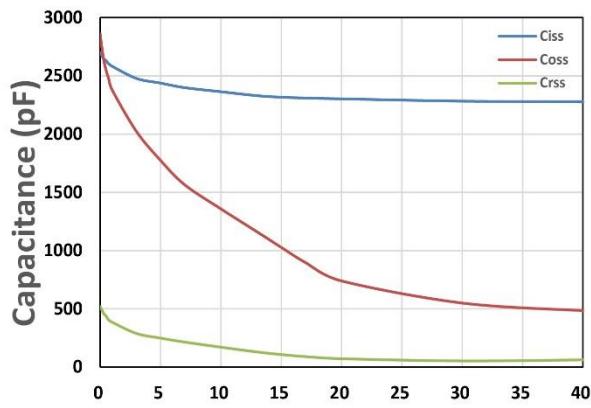
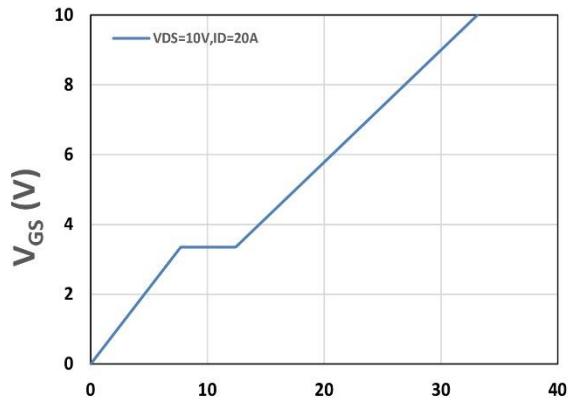


Figure 6. Source-Drain Diode Forward

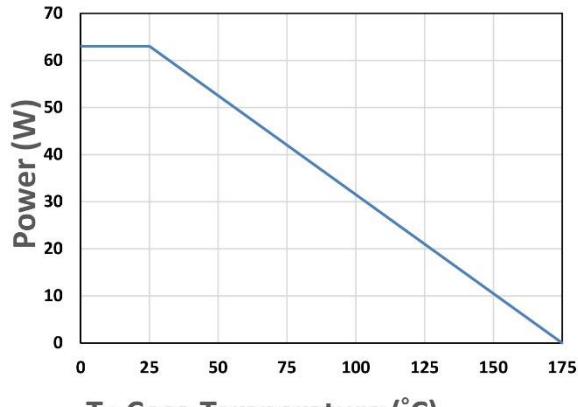
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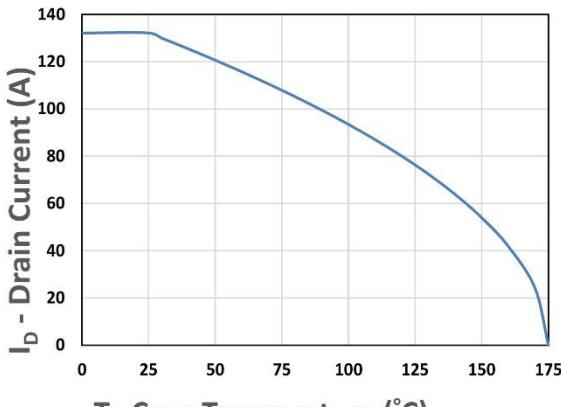
V<sub>DS</sub> - Drain - Source Voltage (V)  
Figure 7. Capacitance



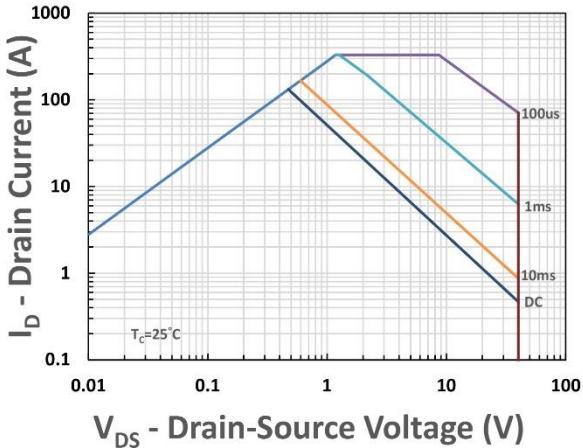
Q<sub>g</sub>, Total Gate Charge (nC)  
Figure 8. Gate Charge Characteristics



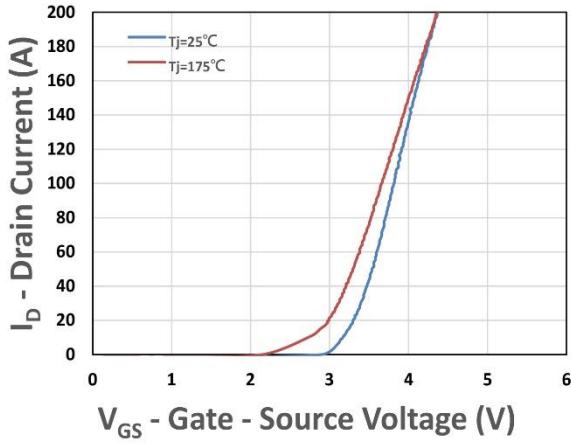
T<sub>c</sub>-Case Temperature (°C)  
Figure 9. Power Dissipation



T<sub>c</sub>-Case Temperature (°C)  
Figure 10. Drain Current



V<sub>DS</sub> - Drain-Source Voltage (V)  
Figure 11. Safe Operating Area



V<sub>GS</sub> - Gate - Source Voltage (V)  
Figure 12. Transfer Characteristics

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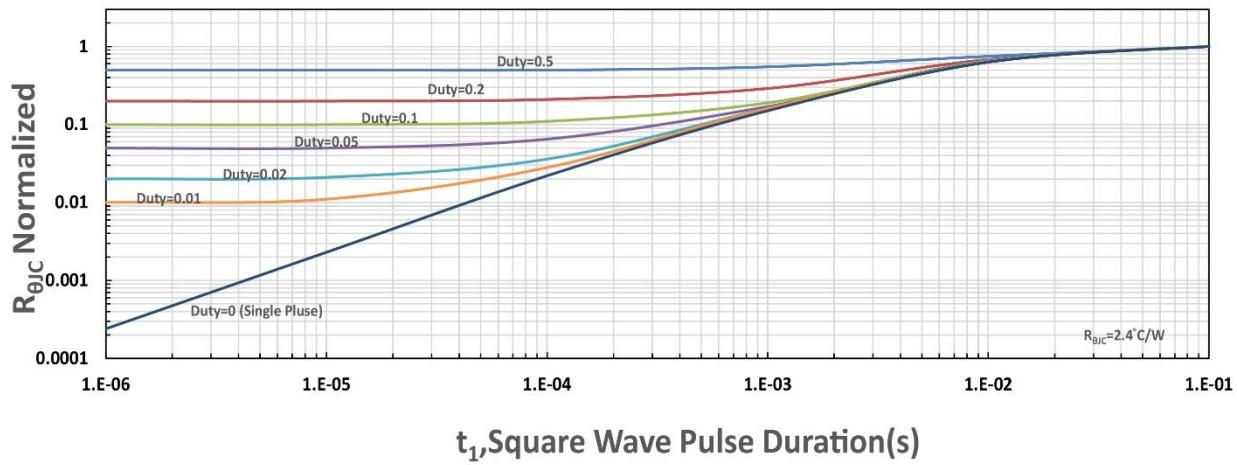


Figure 13.  $R_{\theta JC}$  Transient Thermal Impedance